

FOR IMMEDIATE RELEASE

AMD and Celsia Technologies Collaborate on High Efficiency GPU Cooling Solution

AMD invites Celsia to become part of its technology development project and present at the 2008 AMD Technical Forum and Exposition

SAN JOSE, California, October 20, 2008 – Celsia Technologies (OTCBB: CSAT) is partnering with AMD’s graphics product group on a vapor chamber based cooling solution for high end graphics cards. The cooling module includes Celsia’s patented NanoSpreader™ that significantly outperforms competing heat pipe based solutions.

“Working with AMD, we were able to meet all of the design criteria for a new GPU cooler. Namely, it had to be lighter, perform better and be lower cost than the current heat pipe based design,” said Joe Formichelli, Celsia’s CEO. “Unlike thermal modules using heat pipes, our two-phase NanoSpreader comes in direct contact with the heat source whereby removing costly, heavy base plates.”

As part of AMD’s technology development project, Celsia has been invited to present at the 2008 AMD Technical Forum and Exposition tomorrow in Taiwan. Additionally, a short video explaining Celsia’s NanoSpreader vapor chamber technology will be shown as part of the conference’s opening presentation.

OEM/ODMs working with AMD on next generation graphics cards are invited to contact Evelyn Lu (elu@celsiatechnologies.com) at Celsia for more information and pricing of its innovative NanoSpreader thermal modules.

About Celsia Technologies

Celsia Technologies is a full solution provider and licensor of thermal management products and technology for the PC (server, notebook, desktop), consumer electronics, and LED lighting / display industries. The company, working with many of the largest processor manufacturers, OEMs, and display manufacturers, is a leader in developing and commercializing next-generation cooling solutions built on patented micro thermofluidic technology. Celsia Technologies’ extensive intellectual property portfolio includes patents registered in Korea, the U.S., Japan and Taiwan, with patents pending in the EU, Russia, India and China. For more information, visit celsiatech.com.

Forward Looking Statements

This press release contains forward-looking statements, involving risks and uncertainties. Such statements are based on management’s current expectations and are subject to certain factors, risks, and uncertainties that may cause actual results, events and performance to differ materially from those referred to or implied by such statements. In addition, actual future results may differ materially from those anticipated, depending on a variety of factors which include, but are not limited to, Celsia Technologies’ ability to attract investors,

Celsia Technologies' future operating results, and general economic conditions affecting consumer spending, including uncertainties relating to global political conditions, such as terrorism and the conflict with Iraq. Readers are cautioned not to place undue reliance on these forward-looking statements, which speak only as of the date hereof. Celsia Technologies does not intend to update any of the forward-looking statements after the date of this release to conform these statements to actual results or to changes in its expectations, except as may be required by law.

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